RN00201

Android Release Notes

Rev. android-17.0.0_1.0.0 —
3 November 2026

Release notes

Document information

Information	Content
Keywords	Android, i.MX, android-17.0.0_1.0.0
Abstract	i.MX android-17.0.0_1.0.0 is a release for Android 17 on the i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus, i.MX 95, i.MX 952, and i.MX 937 applications processors of NXP.

1 Release description

i.MX android-17.0.0_1.0.0 is a release for Android 17 on the i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus, i.MX 95, i.MX 952, and i.MX 937 applications processors of NXP.

i.MX android-17.0.0_1.0.0 release includes all necessary code, documents, and tools to assist users in building and running Android 17 on the i.MX 8M Mini EVK, i.MX 8M Nano EVK, i.MX 8M Plus EVK, i.MX 8M Quad WEVK/EVK, i.MX 8ULP EVK, i.MX 8QuadMax MEK, i.MX 8QuadXPlus MEK, i.MX 95 19x19 EVK, FRDM-IMX95, i.MX 952 19x19 EVK, FRDM-IMX952, and FRDM-IMX937. The corresponding release quality for each board is listed in the following table.

Table 1. Release description

Platform name	Release quality
i.MX 8M Mini EVK	GA
i.MX 8M Nano EVK	GA
i.MX 8M Plus EVK	GA
i.MX 8M Quad WEVK/EVK	GA
i.MX 8ULP (A2 9x9) EVK	GA
i.MX 8ULP (A2) EVK	GA
i.MX 8QuadMax	GA
i.MX 8QuadXPlus	GA
i.MX 95 (B0/B2.1 19x19) EVK	GA
FRDM-IMX95 (B0/B2.1 15x15)	GA
i.MX 952 (A1 19x19) EVK	GA
FRDM-IMX952 (A1 15x15)	GA
FRDM-IMX937 (A1)	Beta

The prebuilt images are also included for a quick trial on NXP i.MX 8M Mini EVK, i.MX 8M Nano EVK, i.MX 8M Plus EVK, i.MX 8M Quad WEVK/EVK, i.MX 8ULP EVK, i.MX 8QuadMax MEK, i.MX 8QuadXPlus MEK, i.MX 95 19x19 EVK, FRDM-IMX95, i.MX 952 19x19 EVK, FRDM-IMX952, and FRDM-IMX937 boards and platforms.

This release includes all porting and enhancements based on the Android open source code.

Most of the deliveries in this release are provided in the source code with the exception for some proprietary modules/libraries from third parties.

2 Supported hardware SoC/boards

The supported hardware System-on-Chip (SoCs)/boards are listed as follows:

- i.MX 8M Mini EVK
  Supported daughter boards:
  – With DDR4 RAM, ROHM BD71847 PMIC chip
  – With LPDDR4 RAM, NXP PCA9450 PMIC chip, and NXP 88W8987 Wi-Fi/Bluetooth module.
  Supported mother board:
  – Rev. C mother board
- i.MX 8M Nano EVK

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Supported daughter boards:
– With DDR4 RAM, ROHM BD71847 PMIC chip
– With LPDDR4 RAM, NXP PCA9450 PMIC chip, and NXP 88W8987 Wi-Fi/Bluetooth module
Supported mother board:
– Rev. C mother board
- i.MX 8M Plus (Silicon Revision A1) Rev. A EVK Board and Platform
- i.MX 8M Quad WEVK Rev. B and EVK Rev. A Board and Platform
- i.MX 8ULP (A2) EVK Board and Platform, i.MX 8ULP (A2) EVK 9x9 Board and Platform.
- i.MX 8QuadMax (Silicon Revision B0) MEK Board (Board Rev. B5, Rev. C2, and Rev. E) and Platform
- i.MX 8QuadXPlus (Silicon Revision B0 and C0) MEK Board and Platform
- i.MX 95 Boards and Platforms.
  – i.MX 95 (Silicon Revision B0/B2.1 19x19) EVK Board (Rev. A) and Platform.
  – FRDM-IMX95 (Silicon Revision B0/B2.1 15x15) with LPDDR4x DRAM Board and Platform.
  – FRDM-IMX95 (Silicon Revision B0 15x15) with LPDDR5 DRAM Board and Platform.
- i.MX 952 EVK Boards and Platforms.
  – i.MX 952 (Silicon Revision A1 19x19) EVK Board (Rev. A) and Platform.
  – FRDM-IMX952 (Silicon Revision A1 15x15) Board (Rev. A) and Platform.
- FRDM-IMX937 (A1) Board and Platform.

3 Release package contents

The android-17.0.0_1.0.0 release package includes the following software and documents.

Table 2. Release package contents

i.MX Android proprietary source code package	• `imx-android-17.0.0_1.0.0.tar.gz`: i.MX Android proprietary source code package to enable Android on i.MX boards. For example, Hardware Abstraction Layer implementation, hardware codec acceleration.
Documents	The following documents are included in `android-17.0.0_1.0.0_docs.zip`: • *Android Quick Start Guide* (UG10157): A document that explains how to run the Android platform on an i.MX board using prebuilt images. • *Android User's Guide* (UG10156): A document describing procedures for configuring and building this release package. • *Android Release Notes* (RN00201): A document that introduces key updates and known issues in this release. • *i.MX Android Extended Codec Release Notes* (RN00202): A document that provides the extended codec information. • *i.MX Android Security User's Guide* (UG10158): A document that describes how to do customization work on security features supported by i.MX Android software. • *i.MX Graphics User's Guide* (UG10159): A document that describes GPU 2D API, Tools, Memory, and Application programming guidelines.
Prebuilt images	You can test the Android platform with a prebuilt image on the i.MX reference board before building any code: • `android-17.0.0_1.0.0_image_8mmevk.tar.gz`: Prebuilt images with NXP extended features for the i.MX 8M Mini EVK board. • `android-17.0.0_1.0.0_image_8mnevk.tar.gz`: Prebuilt images with NXP extended features for the i.MX 8M Nano EVK board. • `android-17.0.0_1.0.0_image_8mpevk.tar.gz`: Prebuilt images with NXP extended features for the i.MX 8M Plus EVK board. • `android-17.0.0_1.0.0_image_8mqevk.tar.gz`: Prebuilt images with NXP extended features for the i.MX 8M Quad WEVK/EVK board.

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Table 2. Release package contents...*continued*

	• `android-17.0.0_1.0.0_image_8ulpevk.tar.gz`: Prebuilt images with NXP extended features for the i.MX 8ULP EVK board and i.MX 8ULP EVK 9x9 board. • `android-17.0.0_1.0.0_image_8qmek.tar.gz`: Prebuilt images with NXP extended features for the i.MX 8QuadMax MEK board and i.MX 8QuadXPlus MEK board. • `android-17.0.0_1.0.0_image_95evk.tar.gz`: Prebuilt images with NXP extended features for the i.MX 95 EVK and FRDM-IMX95 boards. • `android-17.0.0_1.0.0_image_952evk.tar.gz`: Prebuilt images with NXP extended features for the i.MX 952 19x19 EVK and FRDM-IMX952 board. • `android-17.0.0_1.0.0_image_937frdm.tar.gz`: Prebuilt images with NXP extended features for the FRDM-IMX937 board. All prebuilt images are in a separate package. See the *Android Quick Start Guide* (UG10157) and *Android User's Guide* (UG10156) to choose the appropriate image.

4 Features

This section provides the features in this package.

Table 3. Features for i.MX 8 SoCs

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
Google Android 17 release	Y	Y	Y	Y	Y	Y	Y	Based on the CP2A android-17.0.0_r1 release.
Linux 6.18.37 kernel (merge with AOSP kernel)	Y	Y	Y	Y	Y	Y	Y	Based on the Linux OS BSP LF6.18.37_2.1.0 release.
Generic Kernel Image (6.18.32)	Y	Y	Y	Y	Y	Y	Y	Based on AOSP android17-6.18.
U-Boot	Y	Y	Y	Y	Y	Y	Y	v2026.04.
Trusty OS	Y	Y	Y	Y	Y	Y	Y	-
Graphic - HW	Y	Y	Y	Y	Y	Y	Y	VeriSilicon GC7000NanoUltra GPU with the 6.4.11.p4 driver for i.MX 8M Mini EVK. VeriSilicon GC7000UL GPU with 6.4.11.p4 driver for i.MX 8M Nano EVK and i.MX 8M Plus EVK. VeriSilicon GC7000L GPU with 6.4.11.p4 driver for i.MX 8M Quad EVK. VeriSilicon GCNANOULTRA31 GPU with 6.4.11.p4 driver for i.MX 8ULP EVK. VeriSilicon GC7000XSVX GPU with 6.4.11.p4 driver FOR i.MX 8Quad Max. VeriSilicon GC7000L GPU with 6.4.11.p4 driver for i.MX 8Quad XPlus.
Graphic - HW 3D acceleration	Y	Y	Y	Y	Y	Y	Y	OpenGL ES1.1/2.0 through GC7000NanoUltra for i.MX 8M Mini EVK.

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
								OpenGL ES1.1/2.0/3.1 through GC7000UL for i.MX 8M Nano EVK and i.MX 8M Plus EVK. OpenGL ES1.1/2.0/3.1 through GC7000L for i.MX 8M Quad EVK. OpenGL ES1.1/2.0/3.1 through GCNANOULTRA31 for i.MX 8ULP EVK. OpenGL ES 1.1/2.0/3.1/3.2 through GC7000XSVX for i.MX 8Quad Max MEK. OpenGL ES 1.1/2.0/3.1 through GC7000L.
Graphic - HW accelerated UI surface composition	Y	Y	Y	Y	Y	Y	Y	OpenGL ES2.0 through GC7000 NanoUltra for i.MX 8M Mini EVK. OpenGL ES3.1 through GC7000 UL for i.MX 8M Nano EVK and i. MX 8M Plus EVK. OpenGL ES3.1 through GC7000L for i.MX 8M Quad EVK. OpenGL ES3.1 through GCNANOULTRA31 for i.MX 8ULP EVK. OpenGL ES 3.2 through GC7000 XSVX for i.MX 8Quad Max MEK. OpenGL ES 3.1 through GC7000L for i.MX 8QuadXPlus MEK.
SCFW	N	N	N	N	N	Y	Y	Version 1.18.0
SECO firmware	N	N	N	N	N	Y	Y	Version 3.8.5 for i.MX 8Quad XPlus. Version 3.8.5-7d5462e6 for i.MX 8Quad Max.
Boot source	SD/eMMC	SD/eMMC	SD/eMMC	SD/eMMC	eMMC	SD/eMMC	SD/eMMC	-
Splash Screen	Y	Y	Y	Y	Y	Y	Y	-
UI (input)	Y	Y	Y	Y	Y	Y	Y	USB Mouse and Multi-touch on the MIPI panel display.
UI (display)	MIPI-DSI-to-HDMI: 1920 x 1080 MIPI panel: 1080 x 1920	MIPI-DSI-to-HDMI: 1920 x 1080 MIPI panel: 1080 x 1920	HDMI: 3840 x 2160 MIPI-to-HDMI: 1920 x 1080 LVDS-to-HDMI: 1280 x 720 LVDS panel: 1920 x 1200 MIPI panel: 1080 x 1920	HDMI: 3840 x 2160 MIPI-to-HDMI: 1280 x 720 MIPI panel: 1080 x 1920 The physical HDMI supports HDMI-CEC	HDMI: 720 x 480 MIPI: 720 x 1280 EPDC: 1024 x 758	HDMI: 3840 x 2160 LVDS-to-HDMI/ MIPI-to-HDMI: 1920 x 1080 MIPI panel: 1080 x 1920 The physical HDMI supports HDMI-CEC	LVDS-to-HDMI/ MIPI-to-HDMI: 1920 x 1080	The listed resolutions are the maximum supported resolutions. They can be adapted by setting the properties.

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
			Dual-channel LVDS to HDMI: 1920 x 1080 The physical HDMI supports HDMI-CEC					
UI (multiple displays)	N	N	Y	Y	N	Y	Y	i.MX 8M Plus EVK supports the combination of 2 to 3 of the following displays: • MIPI-to-HDMI • HDMI • LVDS-to-HDMI i.MX 8M Quad EVK supports MIPI-to-HDMI and HDMI displays. i.MX 8Quad Max MEK supports the combination of 2 to 4 of the following 4 displays: • HDMI_TX • LVDS0_CH0 • LVDS1_CH0 • MIPI_DSI1 And the combination of 2 to 4 of the following 4 displays: • LVDS0_CH0 • LVDS1_CH0 • MIPI_DSI0 • MIPI_DSI1 i.MX 8QuadXPlus MEK supports dual LVDS-to-HDMI displays.
UI (brightness control)	Y	Y	Y	Y	Y	Y	N	With MIPI panel display for all boards.
UI-Low Power Display (LPD)	N	N	N	N	Y	N	N	Shares display with the RTD core.
Storage - External Media	Y	Y	Y	Y	Y	Y	Y	i.MX 8M Mini EVK and i.MX 8M Nano EVK support U-disk on the USB 2.0 port. i.MX 8M Plus EVK, i.MX 8M Quad EVK, i.MX 95 EVK, FRDM-IMX95, i.MX 952 EVK, and FRDM-IMX937 support U-disk on the USB Type-A host port. i.MX 8ULP EVK supports U-disk on the USB 0 port and USB 1 port. i.MX 8Quad Max MEK and i.MX 8 QuadXPlus MEK support U-disk on the USB 2.0 port.
Connectivity - Ethernet	Y	Y	Y	Y	Y	Y	Y	For i.MX 8M Plus EVK, i.MX 95 EVK, and FRDM-IMX95, the

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
								ENET1 port is the default Ethernet port.
Connectivity - Bluetooth wireless technology	88W8987	88W8987	SDIW612	PCIE9098 (Murata LBEE5 ZZ1XL)	SDIW612	PCIE9098 (Murata LBEE5 ZZ1XL)	PCIE9098 (Murata LBEE5 ZZ1XL)	Hardware: • NXP 88W8987 for the i.MX 8M Mini EVK LPDDR4 board and i.MX 8M Nano EVK LPDDR4 board. Profiles: • A2DP Source • AVRCP • BLE Host • HSP • HID Host • HID Device • PAN • OPP
Connectivity - Wi-Fi	88W8987	88W8987	SDIW612	PCIE9098 (Murata LBEE5 ZZ1XL)	SDIW612	PCIE9098 (Murata LBEE5 ZZ1XL)	PCIE9098 (Murata LBEE5 ZZ1XL)	Hardware: • NXP 88W8987 for the i.MX 8M Mini EVK LPDDR4 board and i.MX 8M Nano EVK LPDDR4 board. Features: • STA mode • AP mode • Wi-Fi Direct • AP/STA Concurrency • MAC randomization
Connectivity - USB Tethering	Y	Y	Y	Y	Y	Y	Y	Supports Wi-Fi and Ethernet as upstream.
Power - CPU Freq	Y	Y	Y	Y	N	Y	Y	-
Power - Bus Freq	Y	Y	Y	Y	N	Y	Y	-
ISP	N	N	Y	N	N	N	N	VeriSilicon ISP8000NANO_V1802 with 4.2.2_2026.2 driver/server for i.MX 8M Plus EVK.
Media - Music Play	Y	Y	Y	Y	Y	Y	Y	SSI+WM8524 for i.MX 8M Mini EVK, i.MX 8M Nano EVK, and i. MX 8M Quad EVK. SSI+WM8960+PCM512 (for powersave image) for i.MX 8M Plus EVK. SSI+WM8960 for i.MX 8ULP EVK. WM8960+CS42888+HDMI for i.MX 8Quad Max MEK. WM8960+CS42888 for i.MX 8 QuadXPlus MEK.
Media - Sound Record	Y	Y	Y	Y	Y	Y	Y	PDM for i.MX 8M Mini EVK, i.MX 8M Nano EVK, FRDM-IMX95, FRDM-IMX952, and FRDM-IMX937. AK5558 for i.MX 8M Quad EVK.

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
								SSI+WM8960+PDM for i.MX 8M Plus EVK. SSI+WM8960 for i.MX 8ULP EVK. ESAI+CS42888 for i.MX 8Quad Max MEK and i.MX 8QuadXPlus MEK.
Media - Compress Playback	N	N	Y	N	N	Y	Y	Compress MP3 playback through Sound Open Firmware (SOF).
Media - SOF Audio	-	-	-	-	-	-	-	PCM playback and capture through SOF on i.MX 95 EVK.
Media - Video Play	Y	Y	Y	Y	Y	Y	Y	For i.MX 8M Mini, i.MX 8M plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8QuadXPlus, which have VPU integrated, see the *i.MX Android Extended Codec Release Notes* (RN00202) to find the information about the supported format, resolution, frame rate, and bit rate. For i.MX 8M Nano and i.MX 8ULP, which do not have VPU integrated, the video playback is supported by Google software decoder. For i.MX 8QuadMax, i.MX 8Quad XPlus, i.MX 95, i.MX 952, and i.MX 937, if Trusty OS is used, see Section "Secure firmware loader" in the *i.MX Android Security User's Guide* (UG10158) to flash the keys related to the firmwareloader manually so that the video can play back normally.
Media - HDR Video Play	N	N	N	Y	N	N	N	-
Media - Camera	OV5640 CSI MIPI camera	OV5640 CSI MIPI camera	Two Basler cameras (max. resolution: 1920 x 1080) Basler +OV5640 (Basler max. resolution: 3840 x 2160, depending on the boot parameter) Single Basler (max. resolution:	OV5640 CSI MIPI camera	OV5640 CSI MIPI camera	OV5640 CSI MIPI camera	OV5640 CSI MIPI camera	-

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
			3840 x 2160, depending on the boot parameter) Single OV5640 Two OS08A20 (max. resolution: 1920 x 1080) Single OS08A20 (max. resolution: 3840 x 2160, depending on the boot parameter)					
Media - Camera DeviceAs Webcam	Y	Y	N	Y	Y	Y	Y	Supports MJPEG 1080p and MJPEG 720p streams on i.MX 8M Mini EVK, i.MX 8M Nano EVK, i.MX 8M Plus EVK, i.MX 8M Quad EVK, i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, and FRDM-IMX95. Supports MJPEG 480p stream on i.MX 8ULP EVK. For i.MX 8M Quad, it is only supported on the EVK board, not on the WEVK board.
Media HDMI RX	N	N	N	N	N	Y	N	-
Media - TVIN	N	N	N	N	N	N	N	-
Media - Dual Camera	Y	Y	Y	Y	Y	Y	Y	-
Media - Camcorder	Y	Y	Y	Y	Y	Y	Y	-
Media - USB Camera	Y	Y	Y	Y	Y	Y	Y	USB camera supports C920, C930, and C270 for i.MX 8M Mini EVK, i.MX 8M Nano EVK, i.MX 8M Quad EVK, i.MX 8M Plus EVK, i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, i.MX 952 EVK, and FRDM-IMX937. USB camera supports C270 for i.MX 8ULP EVK. It can only work with the Camera2 Basic application.

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
Media - USB Mic	Y	Y	Y	Y	Y	Y	Y	-
Media - HDMI audio output	N	N	Y	Y	Y	Y	N	-
Media - DSD Playback	Y	N	N	Y	N	N	N	DSD playback on Audio Expansion Board.
Media - MCU Playback	Y	N	Y	N	Y	N	N	Audio playback based on: • FreeRTOS on the Cortex-M4 core for i.MX 8M Mini EVK. • FreeRTOS on the Cortex-M7 core for i.MX 8M Plus EVK. • FreeRTOS on Cortex-M33 core for i.MX 8ULP EVK.
Media - Audio HAT	N	N	N	N	N	N	N	-
Media - MQS audio output	N	N	N	N	N	N	N	-
Media - Hi-Res audio output	Y	N	N	Y	N	Y	Y	High-resolution audio output from Audio. Expansion Board for i.MX 8M Mini EVK and i.MX 8M Quad EVK: • 2-channel: 384000, 768000 sampling rate • 4-channel: 48000, 96000, 192000, 384000, 768000 sampling rate • 6-channel: 48000, 96000, 192000, 384000 sampling rate • 8-channel: 48000, 96000, 192000, 384000, 768000 sampling rate For i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, i.MX 952 19x19 EVK, FRDM-IMX952, and FRDM-IMX937: • 4/6/8-channel: 48000, 96000, 192000 sampling rate
Media - Play Ready DRM	N	N	N	N	N	N	N	-
Media - Wide Vine DRM	N	N	N	N	N	N	N	Supports WideVine DRM Level 1 and Level 3, Widevine CDM version 20.0 and OPK version 20.2.0.
Misc - ADB over USB	Y	Y	Y	Y	Y	Y	Y	-
Misc - Fastboot utility	Y	Y	Y	Y	Y	Y	Y	-
Misc - Factory reset	Y	Y	Y	Y	Y	Y	Y	-
Misc - Recovery mode	Y	Y	Y	Y	Y	Y	Y	Supports installing updates and wiping data.

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
Powerkey - Suspend & Resume	Y	Y	Y	Y	Y	Y	Y	-
Battery - Charger mode	Y	Y	Y	Y	Y	Y	Y	-
Sensor - Magnetometer	N	N	N	N	N	Y	Y	FXOS8700
Sensor - Accelerometer	N	N	N	N	N	Y	Y	FXOS8700
Sensor - Gyroscope	N	N	N	N	N	Y	Y	FXAS2100
Sensor - Light	N	N	N	N	N	Y	Y	ISL29023
Sensor - Pressure	N	N	N	N	N	Y	Y	MPL3115
Sensor - Temperature	N	N	N	N	N	Y	Y	MPL3115
Sensor - Pedometer	N	N	N	N	Y	N	N	-
File Based Encryption	Y	Y	Y	Y	Y	Y	Y	-
USB Accessory	Y	Y	Y	Y	Y	Y	Y	Google AOA v2.0
USB-MTP	Y	Y	Y	Y	Y	Y	Y	-
USB-PTP	Y	Y	Y	Y	Y	Y	Y	-
USB-MIDI	Y	Y	Y	Y	Y	Y	Y	-
Real Time Clock (RTC)	Y	Y	Y	Y	Y	Y	Y	-
Screen Recording	Y	Y	Y	Y	Y	Y	Y	
Ethernet APK	N	N	N	N	N	N	N	-
imx-chip-tool APK	N	Y	N	N	N	N	N	Supports Matter devices control tool `imx-chip-tool apk`.
webGL	Y	Y	Y	Y	Y	Y	Y	-
Vulkan	N	Y	Y	Y	Y	Y	Y	Version 1.3 for i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8Quad Max, and i.MX 8QuadXPlus.
NeuralNetworks	N	Y	Y	Y	Y	Y	Y	-
OTA for A/B	Y	Y	Y	Y	Y	Y	Y	Supports OTA with secure boot and encrypted boot.
USB Type-C PD	Y	Y	Y	Y	N	Y	Y	Supports power role switch with devices that support USB power delivery.
DM Verity	Y	Y	Y	Y	Y	Y	Y	-
TEE backed Keymint HAL	Y	Y	Y	Y	Y	Y	Y	This is based on i.MX Trusty OS TEE firmware.

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Table 3. Features for i.MX 8 SoCs*...continued*

Feature	i.MX 8M Mini EVK	i.MX 8M Nano EVK	i.MX 8M Plus EVK	i.MX 8M Quad WEVK/ EVK	i.MX 8ULP EVK	i.MX 8Quad Max MEK	i.MX 8 Quad XPlus MEK	Remarks
TEE backed AVB	Y	Y	Y	Y	Y	Y	Y	This is based on i.MX Trusty OS TEE firmware and secure storage of eMMC chip. In this release, users need to initialize the RPMB part manually.
Secure boot	Y	Y	Y	Y	Y	Y	Y	Secure boot based on HABv4 for i.MX 8M Mini EVK, i.MX 8M Nano EVK, i.MX 8M Plus EVK, and i.MX 8M Quad EVK. Secure boot based on AHAB for i.MX 8ULP EVK, i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, and i.MX 952 EVK.
Encrypted boot	Y	Y	Y	Y	Y	Y	Y	-
TEE backed security	Y	Y	Y	Y	Y	Y	Y	This is based on the i.MX Trusty OS TEE firmware.
Software backed OEM unlock	Y	Y	Y	Y	Y	Y	Y	Supports software backed OEM Lock AIDL and store the `oem unlocking` flag to the `fbmisc` partition.
Virtualization Android	N	N	N	N	N	N	N	Supports virtualization Android on i.MX 95 Xen.
EdgeLock Secure Enclave HAL	N	N	N	N	N	N	N	Supports EdgeLock Secure Enclave (ELE) HAL.

Table 4. Features for i.MX 9 SoCs

Feature	i.MX 95 19x19 EVK/FRDM-IMX95	i.MX 952 EVK/ FRDM-IMX952	FRDM-IMX937	Remarks
Google Android 17 release	Y	Y	Y	Based on the CP2A android-17.0.0_r1 release.
Linux 6.18.37 kernel (merge with AOSP kernel)	Y	Y	Y	Based on the Linux OS BSP LF6.18.37_2.1.0 release.
Generic Kernel Image (6. 18.32)	Y	Y	Y	Based on AOSP android17-6.18.
U-Boot	Y	Y	Y	v2026.04.
Trusty OS	Y	Y	Y	-
Graphic - HW	Y	Y	Y	Mali-G310 GPU with the r56p0-18eac0 driver for i.MX 95 EVK, i.MX 952 EVK, and FRDM-IMX937.
Graphic - HW 3D acceleration	Y	Y	Y	OpenGL ES 1.1/2.0/3.1 through GC7000L. Vulkan 1.4 through Mali-G310 for i.MX 95 EVK, i.MX 952 EVK, and FRDM-IMX937.
Graphic - HW accelerated UI surface composition	Y	Y	Y	Vulkan 1.4 through Mali-G310 for i.MX 95 EVK, i.MX 952 EVK, and FRDM-IMX937.
SCFW	N	N	N	Version 1.18.0
SECO firmware	N	N	N	-

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Table 4. Features for i.MX 9 SoCs*...continued*

Feature	i.MX 95 19x19 EVK/FRDM-IMX95	i.MX 952 EVK/ FRDM-IMX952	FRDM-IMX937	Remarks
Boot source	SD/eMMC	SD/eMMC	SD/eMMC	-
Splash Screen	Y	Y	Y	-
UI (input)	Y	Y	Y	USB Mouse and Multi-touch on the MIPI panel display.
UI (display)	MIPI-to-HDMI4 K: 3840 x 2160 MIPI-to-HDMI: 1920 x 1080 LVDS-to-HDMI: 1920 x 1080 MIPI Panel: 1080 x 2340 LVDS Panel: 1920 x 1200 BOE panel: 1280 x 800 Waveshare panel: 1024 x 600	i.MX 952 EVK: MIPI-to-HDMI4 K: 3840 × 2160 MIPI-to-HDMI: 1920 x 1080 LVDS-to-HDMI: 1920 x 1080 MIPI Panel: 1080 x 2340 LVDS Panel: 1920 x 1200 LVDS Panel with local dimming: 1920 x 720 FRDM-IMX952: HDMI: 1920 x 1080 BOE panel: 1280 x 800 Waveshare panel: 1024 x 600	HDMI: 1920 x 1080 BOE panel: 1280 x 800 Waveshare panel: 1024 x 600	The listed resolutions are the maximum supported resolutions. They can be adapted by setting the properties.
UI (multiple displays)	Y/N	Y/N	N	i.MX 95 EVK supports dual LVDS-to-HDMI displays, MIPI-to-HDMI, and LVDS-to-HDMI multiple displays. i.MX 952 EVK supports dual LVDS-to-HDMI displays and LVDS-to-HDMI multiple displays.
UI (brightness control)	Y	Y	Y	With MIPI panel display for all boards. With LVDS panel display for i.MX 8M Plus EVK and i.MX 95 EVK.
UI-Low Power Display (LPD)	N	N	N	Shares display with the RTD core.
Storage - External Media	Y	Y	Y	i.MX 8M Plus EVK, i.MX 8M Quad EVK, i.MX 95 EVK, FRDM-IMX95, i.MX 952 EVK, and FRDM-IMX937 support U-disk on the USB Type-A host port.
Connectivity - Ethernet	Y	Y	Y	For i.MX 8M Plus EVK, i.MX 95 EVK, and FRDM-IMX95, the ENET1 port is the default Ethernet port. For i.MX 952 EVK, FRDM-IMX937, the ENET0 port is the default Ethernet port.
Connectivity - Bluetooth wireless technology	PCIE9098/ SDIW612	AW693/ SDIW612	SDIW612	Hardware: • NXP 88W8987 for the i.MX 8M Mini EVK LPDDR4 board and i.MX 8M Nano EVK LPDDR4 board. Profiles: • A2DP Source • AVRCP • BLE Host • HSP • HID Host • HID Device • PAN

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Table 4. Features for i.MX 9 SoCs*...continued*

Feature	i.MX 95 19x19 EVK/FRDM-IMX95	i.MX 952 EVK/ FRDM-IMX952	FRDM-IMX937	Remarks
				• OPP
Connectivity - Wi-Fi	PCIE9098/ SDIW612	AW693/ SDIW612	SDIW612	Hardware: • NXP 88W8987 for the i.MX 8M Mini EVK LPDDR4 board and i.MX 8M Nano EVK LPDDR4 board. Features: • STA mode • AP mode • Wi-Fi Direct • AP/STA Concurrency • MAC randomization
Connectivity - USB Tethering	Y	Y	Y	Supports Wi-Fi and Ethernet as upstream.
Power - CPU Freq	Y	Y	Y	-
Power - Bus Freq	Y	Y	Y	-
ISP	Y	Y	N	VeriSilicon ISP8000NANO_V1802 with 4.2.2_2026.2 driver/server for i.MX 8M Plus EVK. Supports AWB/AGC/AEC for i.MX 95 EVK, FRDM-IMX95, and i.MX 952 EVK,
Media - Music Play	Y	Y	Y	WM8962+CS42888 for i.MX 95 EVK and i.MX 952 19x19 EVK. MQS for FRDM-IMX95, FRDM-IMX952, and FRDM-IMX937.
Media - Sound Record	Y	Y	Y	PDM for i.MX 8M Mini EVK, i.MX 8M Nano EVK, FRDM-IMX95, FRDM-IMX952, and FRDM-IMX937. WM8962+PDM for i.MX 95 EVK and i.MX 952 19x19 EVK.
Media - Compress Playback	N	N	N	Compress MP3 playback through Sound Open Firmware (SOF).
Media - SOF Audio	Y/N	N	N	PCM playback and capture through SOF on i.MX 95 EVK.
Media - Video Play	Y	Y	Y	For i.MX 8QuadMax, i.MX 8QuadXPlus, i.MX 95, i.MX 952, and i.MX 937, if Trusty OS is used, see Section "Secure firmware loader" in the *i.MX Android Security User's Guide* (UG10158) to flash the keys related to the firmwareloader manually so that the video can play back normally.
Media - HDR Video Play	N	N	N	-
Media - Camera	Max. supported resolutions: OS08A20: 3840 x 2160 AP1302: 1280 x 800	Max. supported resolutions: OS08A20: 3840 x 2160 on i.MX 952 EVK, 1920 x 1080 on FRDM-IMX952 AP1302: 1280 x 800	AP1302 (max. resolution: 1280 x 800)	-
Media - Camera DeviceAsWebcam	Y	N	N	Supports MJPEG 1080p and MJPEG 720p streams on i.MX 8M Mini EVK, i.MX 8M Nano EVK, i.MX 8M Plus EVK, i.MX 8M Quad EVK, i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, and FRDM-IMX95.

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Table 4. Features for i.MX 9 SoCs*...continued*

Feature	i.MX 95 19x19 EVK/FRDM-IMX95	i.MX 952 EVK/ FRDM-IMX952	FRDM-IMX937	Remarks
Media HDMI RX	N	N	N	-
Media - TVIN	N	N	N	-
Media - Dual Camera	OS08A20 + OS08A20 (maximum resolution: 3840 x 2160)	OS08A20 + OS08A20 (max. resolution: 1920 x 1080)	AP1302 + AP1302 (max. resolution: 1280 x 800)	-
Media - Camcorder	Y	Y	Y	-
Media - USB Camera	Y	Y	Y	USB camera supports C920, C930, and C270 for i.MX 8M Mini EVK, i.MX 8M Nano EVK, i.MX 8M Quad EVK, i.MX 8M Plus EVK, i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, i.MX 952 EVK, and FRDM-IMX937. It can only work with the Camera2Basic application.
Media - USB Mic	Y	Y	Y	-
Media - HDMI audio output	N	N	N	-
Media - DSD Playback	Y	N	N	DSD playback on Audio Expansion Board.
Media - MCU Playback	Y/N	Y/N	N	Audio playback based on: • FreeRTOS on Cortex-M7 core for i.MX 95 19x19 EVK and i.MX 952 EVK.
Media - Audio HAT	N/Y	N/Y	Y	-
Media - MQS audio output	N/Y	Y	Y	-
Media - Hi-Res audio output	Y	Y	Y	For i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, i.MX 952 19x19 EVK, FRDM-IMX952, and FRDM-IMX937: • 4/6/8-channel: 48000, 96000, 192000 sampling rate
Media - PlayReady DRM	N	N	N	-
Media - WideVine DRM	Y	Y	Y	Supports WideVine DRM Level 1 and Level 3, Widevine CDM version 20.0 and OPK version 20.2.0.
Misc - ADB over USB	Y	Y	Y	-
Misc - Fastboot utility	Y	Y	Y	-
Misc - Factory reset	Y	Y	Y	-
Misc - Recovery mode	Y	Y	Y	Supports installing updates and wiping data.
Powerkey - Suspend & Resume	Y	Y	Y	-
Battery - Charger mode	Y	Y	Y	-
Sensor - Magnetometer	N	N	N	FXOS8700
Sensor - Accelerometer	N	N	N	FXOS8700
Sensor - Gyroscope	N	N	N	FXAS2100
Sensor - Light	N	N	N	ISL29023
Sensor - Pressure	N	N	N	MPL3115
Sensor - Temperature	N	N	N	MPL3115
Sensor - Pedometer	N	N	N	-
File Based Encryption	Y	Y	Y	-

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Table 4. Features for i.MX 9 SoCs*...continued*

Feature	i.MX 95 19x19 EVK/FRDM-IMX95	i.MX 952 EVK/ FRDM-IMX952	FRDM-IMX937	Remarks
USB Accessory	Y	Y	Y	Google AOA v2.0
USB-MTP	Y	Y	Y	-
USB-PTP	Y	Y	Y	-
USB-MIDI	Y	Y	Y	-
Real Time Clock (RTC)	Y	Y	Y	-
Screen Recording	Y	Y	Y	
Ethernet APK	N	N	N	-
imx-chip-tool APK	N	N	N	Supports Matter devices control tool `imx-chip-tool apk`.
webGL	Y	Y	Y	-
Vulkan	N	Y	Y	Version 1.4 for i.MX 95, i.MX 952, and i.MX 937.
NeuralNetworks	Y	Y	Y	-
OTA for A/B	Y	Y	Y	Supports OTA with secure boot and encrypted boot.
USB Type-C PD	Y	Y	Y	Supports power role switch with devices that support USB power delivery.
DM Verity	Y	Y	Y	-
TEE backed Keymint HAL	Y	Y	Y	This is based on i.MX Trusty OS TEE firmware.
TEE backed AVB	Y	Y	Y	This is based on i.MX Trusty OS TEE firmware and secure storage of eMMC chip. In this release, users need to initialize the RPMB part manually.
Secure boot	Y	Y	Y	Secure boot based on AHAB for i.MX 8ULP EVK, i.MX 8Quad Max MEK, i.MX 8QuadXPlus MEK, i.MX 95 EVK, and i.MX 952 EVK.
Encrypted boot	Y	Y	Y	-
TEE backed security	Y	Y	Y	This is based on the i.MX Trusty OS TEE firmware.
Software backed OEM unlock	Y	Y	Y	Supports software backed OEM Lock AIDL and store the `oem unlocking` flag to the `fbmisc` partition.
Virtualization Android	Y	N	N	Supports virtualization Android on i.MX 95 Xen.
EdgeLock Secure Enclave HAL	Y	Y	Y	Supports EdgeLock Secure Enclave (ELE) HAL.

5 Multimedia codecs

For multimedia codecs and features, see the *i.MX Android Extended Codec Release Notes* (RN00202).

6 Extended features

An enhanced multimedia experience is available for the Android platform.

This release delivers an error-resilient, feature-rich multimedia solution by extending the existing multimedia features of the Android platform and introduces additional features. Extended codec packages are provided on nxp.com with controlled access because they require additional licensing by a third party. Contact your sales representative for access.

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For detailed extended and additional features, see the *i.MX Android Extended Codec Release Notes* (RN00202).

7 Change logs

Compared to the android-16.0.0_2.0.0 release, android-17.0.0_1.0.0 release has the following major changes:

- Upgraded the Android code base from BP4A android-16.0.0_r4 to CP2A android-17.0.0_r1.
- Upgraded the i.MX kernel from v6.18.21 to v6.18.37.
- Added support for the FRDM-IMX952 platform.
- Added support for the FRDM-IMX937 platform.
- Added support for the FRDM-IMX95 with the LPDDR5 DRAM platform.
- Added support for the i.MX 95 B2.1 silicon revision.
- Dropped support for the i.MX 952 15x15 EVK platform.
- Integrated the Wi-Fi/Bluetooth WCS 26Q3 release.
- Upgraded the Mali GPU driver from r54p1-11eac0 to r56p0-18eac0.
- Upgraded the CTS tool to 17_r1.
- Upgraded the VTS tool to 17_r1.
- Upgraded the STS tool to 17_sts-r54.
- Upgraded the GTS tool to 14_r1.
- Upgraded the Graphics Allocator HAL from v2 to v3.
- Upgraded the Media Codec2 HAL from v1 to v2.
- Upgraded the Power HAL from v6 to v7.
- Upgraded the USB HAL from v2 to v4.
- Upgraded the USB Gadget HAL from v1 to v2.
- Upgraded the Vibrator HAL from v2 to v4.
- Upgraded the Widevine CDM from version 19.6.0 to 20.0 and OPK from version 19.6 to 20.2.0.

8 Known issues and limitations

The known issues about the hardware and hardware rework instructions are not included in this document. There may be hardware-related reference materials for some reference boards. Make sure to check the link i.MX Application Processors to see if it is applicable.

Table 5. Known issues and limitations

Issue description	Remarks
The Google USB driver must be installed multiple times for the MTP, PTP, MTP&ADB, PTP&ADB, and ADB function settings.	Some Windows XP environments may display MTP and PTP windows even with only PTP enabled in the device.
U-Boot hangs when erasing Kingston SD card.	U-Boot hangs when sending the erase command on some Kingston SD cards.
The SDIW612 (Murata LBES5PL2EL) Wi-Fi&BT M.2 expansion cards are at risk of Wi-Fi disconnection when playing a live streaming video over a Wi-Fi connection due to a known issue in the Wi-Fi driver.	-
For i.MX 95 EVK, the USB-Type C port vbus is connected to a 3.3-V power source. Once it is connected to the host and successfully enumerated by the host, the gadget stage is changed to be configured, and the USB HAL acquires its wakelock. Disconnection	-

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Table 5. Known issues and limitations...*continued*

Issue description	Remarks
from the host does not generate a disconnection interrupt. The gadget state keeps unchanged, and the USB HAL does not release its wakelock.	
The MPPUBK and manufacturing protection features are not ready on i.MX 8ULP, i.MX 95, i.MX 952, and i.MX 937, so features like secure unlock and secure provisioning would be impacted.	-
The i.MX 95 EVK sometimes cannot be powered on by the power switch or PDU due to the PMIC hardware issue.	-

The i.MX 8MQuad WEVK/EVK AUDIO input feature is disabled by default because it does not have an audio input device.	To enable it with an audio board, set the following `bootconfig` in U-Boot.
	`setenv append_bootconfig androidboot.audio.tinyalsa.simulate_input=false`
	`saveenv`

If the USB camera is declared to be supported, the CTS test requires a USB camera to be connected.	To remove the limitation, export an environment variable with the command `export PERMISSION_EXTCAM=false` when building the image to not include `android.hardware.camera.external.xml` under `/vendor/etc/permissions`. For details, see section "Customized configuration" in the *Android User's Guide* (UG10156).

9 Acronyms

Table 6. Acronyms

Acronym	Description
AHAB	Advanced High Assurance Boot
AIDL	Android Interface Definition Language
AOSP	Android Open Source Project
AVB	Android Verified Boot
CTS	Compatibility Test Suite
DDR4	Double Data Rate 4
eMMC	Embedded Multi-Media Card
EVK	Evaluation Kit
GTS	Google Test Suite
HAL	Hardware Abstraction Layer
HID	Human Interface Device
ISP	Image Signal Processor
LPDDR4	Lower Power Double Data Rate 4
MEK	Multisensory Enablement Kit
MTP	Media Transfer Protocol
OS	Operating system

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Table 6. Acronyms...*continued*

Acronym	Description
OTA	Over-The-Air programming
PDU	Power Distribution Unit
PMIC	Power Management Integrated Circuit
RPMB	Replay Protected Memory Block
SCFW	System Controller Firmware
SECO	Secure Controller
SoC	System on Chip
STS	Security Test Suite
TEE	Trusted Execution Environment
U-Boot	Universal Boot Loader
VTS	Vendor Test Suite

10 Note about the source code in the document

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11 Revision history

Revision history

Document ID	Release date	Description
RN00201 v.android-17.0.0_1.0.0	3 November 2026	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus, i.MX 95, i.MX 952 GA release, and FRDM-IMX937 Beta release.

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Revision history...*continued*

Document ID	Release date	Description
RN00201 v.android-16.0.0_2.0.0	24 July 2026	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus, i.MX 95 GA release, and i.MX 952 Beta release.
RN00201 v.android-16.0.0_1.4.0	1 April 2026	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus, and i.MX 95 GA release.
RN00201 v.android-16.0.0_1.2.0	6 January 2026	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus, and i.MX 95 GA release.
RN00201 v.android-16.0.0_1.0.0	28 October 2025	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus GA release, and i.MX 95 Beta release.
RN00201 v.android-15.0.0_2.0.0	24 July 2025	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus GA release, i.MX 95 19x19 EVK Beta release, and i.MX 95 15x15 EVK Alpha release.
RN00201 v.android-15.0.0_1.2.0	11 April 2025	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus GA release, and i.MX 95 Beta release.
RN00201 v.android-15.0.0_1.0.0	24 January 2025	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus GA release, and i.MX 95 Beta release.
RN00201 v.android-14.0.0_2.2.0	18 October 2024	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus GA release, i.MX 95 (A1 15x15) Alpha release, and i.MX 95 (A1 19x19) Beta release.
RN00201 v.android-14.0.0_2.0.0	9 August 2024	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8ULP, i.MX 8QuadMax, i.MX 8QuadXPlus GA release, and i.MX 95 Alpha release. Updated the document ID.
ARN v.android-14.0.0_1.2.0	19 April 2024	i.MX 8ULP EVK, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8Quad XPlus GA release.
ARN v.android-14.0.0_1.0.0	6 February 2024	i.MX 8ULP EVK, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8Quad XPlus GA release.
ARN v.android-13.0.0_2.2.0	24 October 2023	i.MX 8ULP EVK, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8Quad XPlus GA release.
ARN v.android-13.0.0_2.0.0	07/2023	i.MX 8ULP EVK Beta release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8 QuadXPlus GA release.
ARN v.android-13.0.0_1.2.0	03/2023	i.MX 8ULP EVK Beta release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8 QuadXPlus GA release.
ARN v.android-13.0.0_1.0.0	01/2023	i.MX 8ULP EVK Beta release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8 QuadXPlus GA release.

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Revision history...*continued*

Document ID	Release date	Description
ARN v.android-12.1.0_1.0.0	10/2022	i.MX 8ULP EVK Beta release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8 QuadXPlus GA release.
ARN v.android-12.0.0_2.0.0	07/2022	i.MX 8ULP EVK Beta release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, and i.MX 8M Quad GA release.
ARN v.android-12.0.0_1.0.0	03/2022	i.MX 8ULP EVK Beta release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, and i.MX 8M Quad GA release.
ARN v.android-11.0.0_2.6.0	01/2022	i.MX 8ULP EVK Beta release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, and i.MX 8M Quad GA release.
ARN v.android-11.0.0_2.4.0	10/2021	i.MX 8ULP EVK Alpha release, i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, and i.MX 8M Quad GA release.
ARN v.android-11.0.0_2.2.0	07/2021	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, and i.MX 8M Quad GA release.
ARN v.android-11.0.0_2.0.0	04/2021	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Plus, and i.MX 8M Quad GA release.
ARN v.android-11.0.0_1.0.0	12/2020	i.MX 8M Plus EVK Beta release, and all the other i.MX 8 GA release.
ARN v.android-10.0.0_2.3.0	07/2020	i.MX 8M Plus EVK Beta1 release, and all the other i.MX 8 GA release.
ARN v.android-10.0.0_2.0.0	05/2020	i.MX 8M Mini, i.MX 8M Nano, i.MX 8M Quad, i.MX 8Quad Max, and i.MX 8QuadXPlus GA release.
ARN v.android-10.0.0_2.1.0	04/2020	i.MX 8M Plus Alpha and i.MX 8QuadXPlus Beta release.
ARN v.android-10.0.0_1.0.0	03/2020	Deleted the Android 10 image.
ARN v.android-10.0.0_1.0.0	02/2020	i.MX 8M Mini, i.MX 8M Quad, i.MX 8QuadMax, and i.MX 8 QuadXPlus GA release.
ARN v.P9.0.0_2.0.0-ga	08/2019	Updated the location of the SCFW porting kit.
ARN v.P9.0.0_2.0.0-ga	04/2019	i.MX 8M, i.MX 8QuadMax, i.MX 8QuadXPlus GA release.
ARN v.P9.0.0_1.0.0-ga	01/2019	i.MX 8M, i.MX 8QuadMax, i.MX 8QuadXPlus GA release.
ARN v.P9.0.0_1.0.0-beta	11/2018	Initial release

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Contents

1 Release description 2
2 Supported hardware SoC/boards 2
3 Release package contents 3
4 Features 4
5 Multimedia codecs 16
6 Extended features 16
7 Change logs 17
8 Known issues and limitations 17
9 Acronyms 18
10 Note about the source code in the document 19
11 Revision history 19
Legal information 22

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